

PATENT ASSIGNMENT COVER SHEET

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CONVEYING PARTY DATA

Name	Execution Date
BING DAI	02/24/2020
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JIAQI ZHU	02/24/2020
LEI YANG	02/24/2020
WENXIN CAO	02/24/2020
KANG LIU	02/24/2020
JIECAI HAN	02/24/2020
GUOYANG SHU	02/24/2020
GE GAO	02/24/2020
KAILI YAO	02/24/2020
BENJIAN LIU	02/24/2020

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16800689

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PATENT

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DATE SIGNED:	03/03/2020
Total Attachments: 4 source=Copy of executed Assignment#page1.tif source=Copy of executed Assignment#page2.tif source=Copy of executed Assignment#page3.tif source=Copy of executed Assignment#page4.tif	

ASSIGNMENT

WHEREAS, We, DAI, Bing, ZHAO, Jiwen, ZHU, Jiaqi, YANG, Lei, CAO, Wenxin, LIU, Kang, HAN, Jiecai, SHU, Guoyang, GAO, Ge, YAO, Kaili and LIU, Benjian, all of Harbin, Heilongjiang, China, hereby declare that we are the original inventors of the invention relating to a METHOD FOR PREPARING DIAMOND-ASSISTED HEAT-DISSIPATION SILICON CARBIDE SUBSTRATE GaN HEMT's THROUGH A DIRECT GROWTH METHOD for which we are about to make application for Letters Patent of the United States; and

WHEREAS, Harbin Institute of Technology, having its principal place of business at 92 Dazhi West Street, Nangang District, Harbin, Heilongjiang, China (150001), is desirous of acquiring an interest in, to and under said invention, said application and any and all Letters Patent which may be granted for or upon said invention in the United States of America and all countries foreign thereto;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we, DAI, Bing, ZHAO, Jiwen, ZHU, Jiaqi, YANG, Lei, CAO, Wenxin, LIU, Kang, HAN, Jiecai, SHU, Guoyang, GAO, Ge, YAO, Kaili and LIU, Benjian, have sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Harbin Institute of Technology the full and exclusive right, title and interest, throughout the world, in, to and under said invention as fully set forth and described in the above-identified application; in, to and under said application; in, to and under any and all refilings, divisions and continuations of said application; in, to and under any and all Letters Patent of the United States of America which may issue from said application, refilings, divisions and continuations; in, to and

under any and all reissues of said Letters Patent of the United States of America; in, to and under any and all applications for Letters Patent upon said invention which may hereafter be filed in any and all countries foreign to the United States of America; in, to and under any and all re filings, divisions and continuations of said foreign-filed applications; in, to and under any and all Letters Patent of countries foreign to the United States of America, which may issue from the said foreign-filed applications, re filings, divisions and continuations; and in, to and under any and all extensions of, and additions to, said Letters Patent of countries foreign to the United States of America, the same to be held and enjoyed by said Harbin Institute of Technology for its own use and behoof, and for its successors, legal representatives and assigns, to the full end of the term for which said Letters Patent may be granted, and we do hereby authorize and request the Commissioner of Patents to issue the said Letters Patent in accordance with this assignment.

EXECUTED this 24th day of February, 2020.

DAI, Bing
DAI, Bing

EXECUTED this 24th day of February, 2020.

ZHAO, Jiwen
ZHAO, Jiwen

EXECUTED this 24th day of February, 2020.

ZHU, Jiaqi
ZHU, Jiaqi

EXECUTED this 24th day of February, 2020.

YANG, Lei
YANG, Lei

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CAO, Wenxin

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SHU, Guoyang

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GAO, Ge
GAO, Ge

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YAO, Kaili
YAO, Kaili

EXECUTED this 24th day of February, 2020.

LIU, Benjian
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